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Titolo	M & A : a practical guide to doing the deal / / Jeffrey C. Hooke
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ISBN	1-118-81701-X 1-118-81704-4
Edizione	[Second edition.]
Descrizione fisica	1 online resource (227 p.)
Collana	Wiley finance series
Classificazione	BUS017000
Disciplina	658.1/62
Soggetti	Consolidation and merger of corporations - Finance
Lingua di pubblicazione	Inglese
Formato	Materiale a stampa
Livello bibliografico	Monografia
Note generali	Includes index.
Nota di bibliografia	Includes bibliographical references and index.
Nota di contenuto	Machine generated contents note: Preface Part One: The Big Picture Chapter 1: The Global M&A Market Chapter 2: Comparing M&A Trends in the U.S. and Other Nations Chapter 3: The Buyer's Viewpoint Chapter 4: Three Financial Tactics Part Two: Finding a Deal Chapter 5: Finding a Deal: The Importance of a Plan Chapter 6: Finding a Deal: Defining the Search Parameters Chapter 7: Finding a Deal: Starting the Search Chapter 8: Finding a Deal: Likely Results of a Search Chapter 9: Key Risks Part Three: Target Financial Analysis Chapter 10: Historical Financial Analysis Chapter 11: Company Classifications Chapter 12: Financial Projections, Stand-Alone Part Four: Acquisition Valuation Chapter 13: Valuation Methodologies Chapter 14: Discounted Cash Flow in M&A Valuation Chapter 15: Comparable Public Companies and Valuation Chapter 16: Comparable M&A Deals, Leveraged Buyouts and Valuation Chapter 17: Special Cases in Valuation Part Five: Combination, the Sale Process, Structures and Special Situations Chapter 18: Buyer and Seller Financial Combination Chapter 19: When to Sell a Company or Division Chapter 20: Going through a Sale Process Chapter 21: Legal and Tax Structures Chapter 22: Special Situations Chapter 23: Final Thoughts About the Author Index.
Sommario/riassunto	"The comprehensive M&A guide, updated to reflect the latest changes in the M&A environmentM&A provides a practical primer on mergers and acquisitions for corporate executives and anyone involved in the

deal. Its comprehensive approach covers each step in the process, from finding an opportunity, to analyzing the potential, to closing the deal, with new coverage of private equity funds and international transactions. This updated second edition also includes information on emerging markets, natural resource valuation, hostile takeovers, special deals, and more, plus new examples and anecdotes taken from more current events. Additional illustrations and charts help readers quickly grasp the complex information, providing a complete reference easily accessible by anyone involved in M&A. The mergers and acquisitions environment has changed in the thirteen years since M&A was initially published, creating a tremendous need for authoritative M&A guidance from a banker's perspective. This M&A update fills that need by providing the characteristic expert guidance in clear, concise language, complete with the most up-to-date information. Discover where M&A fits into different corporate growth strategies, and the unique merits it confers. Delineate clear metrics for determining risk, valuation, and optimal size of potential acquisitions. Gain deeper insight into the fundamentals of negotiation, due diligence, and structuring. Understand the best time to sell, the best way to sell, and the process of the sale itself. In the past decade, the dollar value of M&A deals has jumped ten-fold, and the number of individuals involved has expanded considerably. More and more executives, analysts, and bankers need to get up-to-date on the mechanics of M&A, without wading through volume after volume of dense, legalistic jargon. Finally, M&A is back - providing a complete reference to the current state of the M&A environment"--

2. Record Nr.	UNINA9910299750803321
Autore	Mardiguian Michel
Titolo	Controlling Radiated Emissions by Design / / by Michel Mardiguian
Pubbl/distr/stampa	Cham : , : Springer International Publishing : , : Imprint : Springer, , 2014
ISBN	3-319-04771-X
Edizione	[3rd ed. 2014.]
Descrizione fisica	1 online resource (371 p.)
Disciplina	620 621.381 621.3815
Soggetti	Electronics Microelectronics Electronic circuits Electronics and Microelectronics, Instrumentation Circuits and Systems
Lingua di pubblicazione	Inglese
Formato	Materiale a stampa
Livello bibliografico	Monografia
Note generali	Description based upon print version of record.
Nota di bibliografia	Includes bibliographical references and index.
Nota di contenuto	Generalities -- Electric & Magnetic Fields from Simple Circuit Shapes -- Fields Radiated by Non-Sinusoidal Sources -- General Strategy for Designing Low Radiation Products -- Control at Chip & Integrated Circuit Level -- Printed Circuit Board Design -- Emission Control in Mother Boards & Backplanes -- Controlling Radiation from Switch Mode Power Supplies -- Reducing Radiated EMI by Internal Cabling & Packaging -- Box Shielding -- Controlling Radiated Emissions at I/O Ports & External Cables -- Principal Radiated Emission Specifications & Test Methods -- Troubleshooting Radiated EMI Problems -- Appendix A: The Modified Dipole Model -- Appendix B: Some Validation Results Supporting the Simplified Radiation Model -- Appendix C: Inductances and Capacitances of PCB Traces -- Appendix D: A few Equivalent Circuits for Component Modeling via SPICE.
Sommario/riassunto	The 3rd edition of Controlling Radiated Emissions by Design has been updated to reflect the latest changes in the field. New to this edition is material related to technical advances, specifically super-fast data rates on wire pairs, with no increase in RF interference. Throughout the

book, details are given to control RF emissions using EMC design techniques. This book retains the step-by-step approach for incorporating EMC into every new design from the ground up. It describes the selection of quieter IC technologies, their implementation into a noise-free printed circuit layout, and the gathering of these into a low emissions package. Also included is how to design an I/O filter, along with connectors and cable considerations. All guidelines are supported throughout with comprehensive calculated examples. Design engineers, EMC specialists, and technicians will benefit from learning about the development of more efficient and economical control of emissions.
